International IOR Rectifier

HFA30PB120PbF

Ultrafast, Soft Recovery Diode

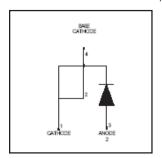
HEXFRED™

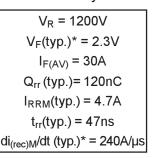
Features

- Ultrafast Recovery
- Ultrasoft Recovery
- Very Low I_{RRM}
- Very Low Q_{rr}
- Guaranteed Avalanche
- Specified at Operating Conditions
- Lead-Free

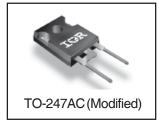
Benefits

- Reduced RFI and EMI
- · Reduced Power Loss in Diode and Switching Transistor
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count





PD-95686A



Description

International Rectifier's HFA16PB120 is a state of the art center tap ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 volts and 16 amps continuous current, the HFA16PB120 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current (IRRM) and does not exhibit any tendency to "snap-off" during the tb portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA16PB120 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

Absolute Maximum Ratings

	Parameter	Max.	Units
V_R	Cathode-to-Anode Voltage	1200	V
I _F @ T _C = 100°C	Continuous Forward Current	30	
I _{FSM}	Single Pulse Forward Current	120	Α
I _{FRM}	Maximum Repetitive Forward Current	90	
P _D @T _C = 25°C	Maximum Power Dissipation	350	W
P _D @T _C = 100°C	Maximum Power Dissipation	140	
T_J	Operating Junction and	-55 to + 150	°C
T _{STG}	Storage Temperature Range		

11/2/04 * 125°C

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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions	
V_{BR}	Cathode Anode Breakdown Voltage	1200			٧	I _R = 100μA	
			2.4	4.1		I _F = 30A	
V_{FM}	Max Forward Voltage		3.1	5.7	٧	I _F = 60A See Fig. 1	
			2.3	4.0		I _F = 30A, T _J = 125°C	
I _{RM}	Max Reverse Leakage Current		1.3	40	μA	$V_R = V_R$ Rated See Fig. 2	
			1.1	4000		$T_J = 125^{\circ}C, V_R = 0.8 \times V_R \text{ Rated}$	
Ст	Junction Capacitance		50	75	pF	V _R = 200V See Fig. 3	
Ls	Series Inductance		8.0		nΗ	Measured lead to lead 5mm from	
						package body	

Dynamic Recovery Characteristics @ $T_J = 25$ °C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions	
t _{rr}	Reverse Recovery Time		47			$I_F=1.0A$, $di_F/dt=200A/\mu s$, $V_R=30V$	
t _{rr1}	See Fig. 5, 10		110	170	ns	T _J = 25°C	
t _{rr2}			170	260		T _J = 125°C	
I _{RRM1}	Peak Recovery Current		10	15	Α	T _J = 25°C	I _F = 30A
I _{RRM2}	See Fig. 6		16	24		T _J = 125°C	
Q _{rr1}	Reverse Recovery Charge		650	980	nC	T _J = 25°C	V _R = 200V
Q _{rr2}	See Fig. 7		1540	2310		T _J = 125°C	
di _{(rec)M} /dt1	Peak Rate of Fall of Recovery Current		270		A/µs	T _J = 25°C	di _F /dt =200A/µs
di _{(rec)M} /dt1			240			T _J = 125°C	

Thermal - Mechanical Characteristics

	Parameter	Min.	Тур.	Max.	Units
T _{lead} ②	Lead Temperature			300	ô
R_{qJC}	Thermal Resistance, Junction-to-Case			0.36	
R_{qJA} 3	Thermal Resistance, Junction-to-Ambient			80	°C/W
R _{qcs} @	Thermal Resistance, Case-to-Heat Sink		0.50		
Wt	Weight		2.0 (0.07)		g (oz.)
	Mounting Torque	6.0		12	kg-cm
		5.0		10	lbf·in

Notes:

- \odot $\;$ L=100 $\mu H,$ duty cycle limited by max T_J
- ② 0.063 in. from Case (1.6mm) for 10 sec
- 3 Typical Socket Mount
- Mounting Surface, Flat, Smooth and Greased

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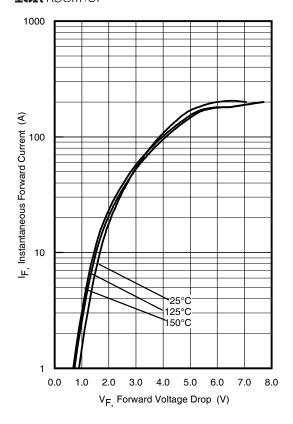


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

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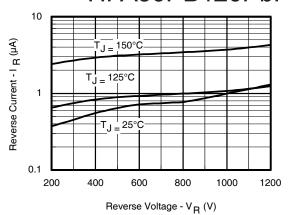


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

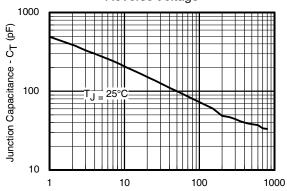


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

Reverse Voltage - V_R (V)

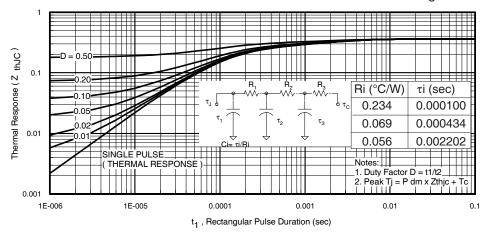


Fig. 4 - Maximum Thermal Impedance Z_{thic} Characteristics

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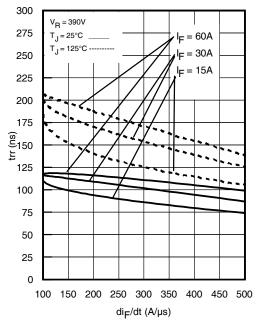


Fig. 5 - Typical Reverse Recovery vs. dif/dt, (per Leg)

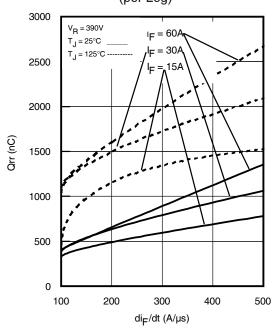


Fig. 7 - Typical Stored Charge vs. di_f/dt, (per Leg)

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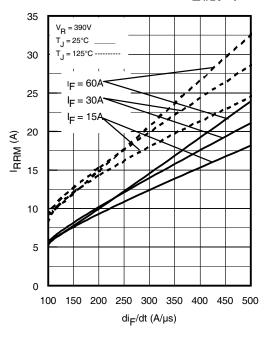


Fig. 6 - Typical Recovery Current vs. di_f/dt, (per Leg)

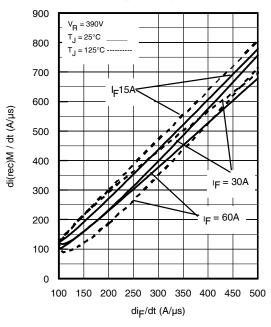


Fig. 8 - Typical di_{(rec)M}/dt vs. di_f/dt, (per Leg)

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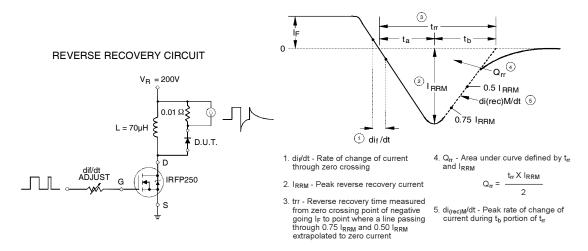


Fig. 9 - Reverse Recovery Parameter Test Circuit

Fig. 10 - Reverse Recovery Waveform and Definitions

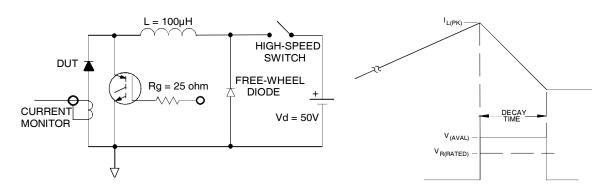


Fig. 11 - Avalanche Test Circuit and Waveforms

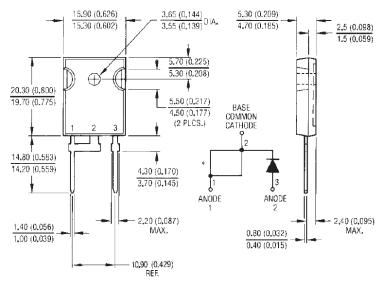
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TOR Rectifier

TO-247AC (Modified) Package Outline Drawing

Dimensions are in millimeters (inches)



Conforms to JEDEC Outline TO-247AC(Modified)
Dimensions in millimeters and inches

Note: Marking "P" indicates Lead-Free

Data and specifications subject to change without notice.



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